# **IEC Logic Symbol**

OE (1) EN LE (11) C1		
D0 (2) 1 D D1 (4)	⊳ ∇	(19) Q0 (18) Q1 (17) Q2 (16) Q3 (15) Q4 (14) Q5 (13) Q6 (12) Q7

### **Truth Table**

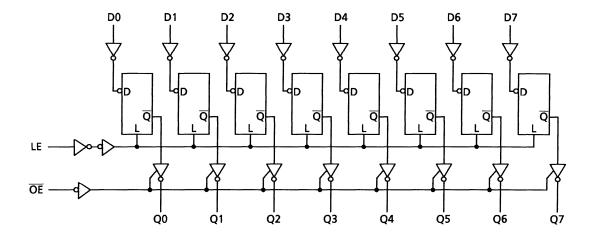
	Output		
ŌĒ	LE	D	Q
Н	Х	Х	HZ
L	L	Х	Qn
L	Н	L	L
L	Н	Н	Н

X: Don't care

HZ: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

### **System Diagram**



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#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V <sub>CC</sub> /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to  $65^{\circ}C$ . From Ta = 65 to  $85^{\circ}C$  a derating factor of -10 mW/°C shall be applied until 300 mW.

#### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	٧
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.



### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			-	Га = 25°(		Ta = -40 to 85°C		Unit
	- <b>,</b>			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
				2.0	1.50	_	_	1.50	_	
High-level input voltage	$V_{IH}$		_	4.5	3.15			3.15	_	V
ŭ			6.0	4.20	—	_	4.20	_		
				2.0	_		0.50	_	0.50	
Low-level input voltage	$V_{IL}$		_	4.5	_	_	1.35	_	1.35	V
Ğ				6.0	_	_	1.80	_	1.80	
				2.0	1.9	2.0	_	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage	$V_{OH}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		6.0	5.9	6.0	_	5.9		V
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
				2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	$V_{OL}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		6.0		0.0	0.1	_	0.1	V
			$I_{OL} = 6 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
			I <sub>OL</sub> = 7.8 mA	6.0		0.18	0.26	_	0.33	
3-state output off-state current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	_	±0.5	_	±5.0	μА
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0			±0.1	_	±1.0	μА
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or	r GND	6.0	_	_	4.0	_	40.0	μА

# Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width			2.0	_	75	95	
· ·	t <sub>W (H)</sub>	_	4.5	_	15	19	ns
(LE)			6.0	_	13	16	
Minimum set-up time			2.0	_	50	65	
· ·	ts	_	4.5	_	10	13	ns
(data)			6.0	_	9	11	
Minimum hold time			2.0	_	5	5	
(data)	t <sub>h</sub>	_	4.5	_	5	5	ns
			6.0	_	5	5	



### AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics Symbol		Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
5.10.10.10.10.10.10.10.10.10.10.10.10.10.			CL (pF)	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Output transition time	t <sub>TLH</sub> t <sub>THL</sub>	_	50	2.0 4.5 6.0	_ _ _	20 6 5	60 12 10	_ _ _	75 15 13	ns
Propagation delay time (LE-Q)	<sup>t</sup> pLH <sup>t</sup> pHL	_	150	2.0 4.5 6.0 2.0 4.5 6.0		50 15 13 60 20 17	115 23 20 155 31 26		145 29 25 195 39 33	ns
Propagation delay time (D-Q)	t <sub>P</sub> LH t <sub>P</sub> HL	_	150	2.0 4.5 6.0 2.0 4.5 6.0	   	42 14 12 57 19	110 22 19 150 30 26		140 28 24 190 38 32	ns
Output enable time	<sup>t</sup> pZL t <sub>pZH</sub>	$R_L = 1 \text{ k}\Omega$	50 150	2.0 4.5 6.0 2.0 4.5	_ _ _ _	55 17 14 66 22	140 28 24 180 36	_ _ _ _	175 35 30 225 45	ns
Output disable time	t <sub>pLZ</sub>	R <sub>L</sub> = 1 kΩ	50	6.0 2.0 4.5 6.0		19 40 17 15	31 125 25 21		38 155 31 26	ns
Input capacitance	C <sub>IN</sub>				_	5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>	_	_		_	10	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	_	_		_	51	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

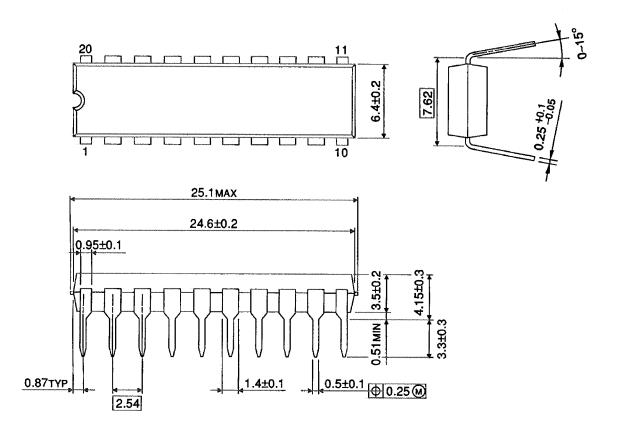
$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$  (per latch)

And the total CPD when n pcs. of latch operate can be gained by the following equation:

$$C_{PD}$$
 (total) = 33 + 18 · n

# **Package Dimensions**

DIP20-P-300-2.54A Unit: mm

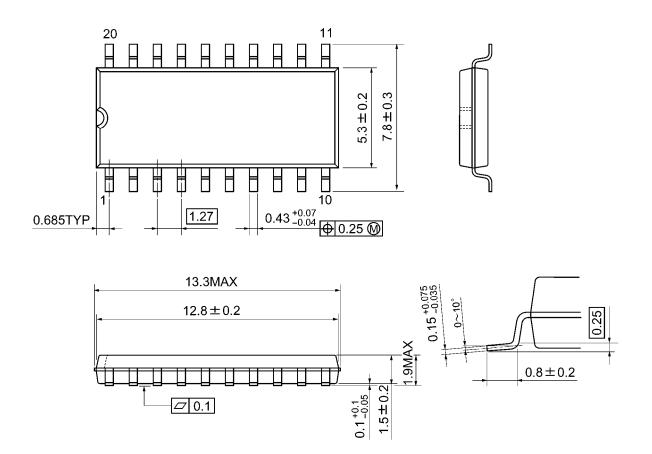


Weight: 1.30 g (typ.)



# **Package Dimensions**

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

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